PCN Number:	N Number: 20150106000 PCN Date: 02/03/2015						/2015			
				90100					,	· - -
Title: Datasheet update for LMP90097/98/99/90100 Customer Contact: PCN Manager Dept: Quality Services										
Change Type:	<u> </u>	<u>cri manager</u>	БСР	<u> </u>	Zuun	СУ	<u> </u>			
Assembly Site			Design			\neg	\Maf	or Run	an Sita	
Assembly Process		Design Design		ıt.			Wafer Bump Site Wafer Bump Mater		ial	
Assembly Process Assembly Materials		Part number char						Wafer Bump Process		
	Mechanical Specification				L	\dashv		er Fab		33
	ing/Shipping/Labeling Test Process			=			Material	ls		
гаскиту/ этпррт				r Fab Process						
PCN Details										
Description of Cha	nge									
	Texas Instruments Incorporated is announcing an information only notification.									
			-		•					
The product datashe	et(s)	is being u	pdated as sum	ımarize below	٧.					
The fellowing state	- l-:			.:1_						
The following chang	e nis	tory provid	es further deta	IIIS						
								Ţ,	EXAS NSTRUME	NTC
LMP90100, LMP90099	LMPS	0098, LMP90	097					4 II	NSTRUME	N15
SNAS510R – JANUARY 2011 – R		-							www.ti.	com
Ohan maa fuam Daniaian	O /D		- Bisisaa B							
Changes from Revision	Changes from Revision Q (December 2014) to Revision R Page						age			
Added SDO Timing Requirements back in.						12				
Changes from Revision	Changes from Revision P (March 2013) to Revision Q							age		
		<u> </u>		ble Feeture Deep	rintion		ation D	ouioo Fu	national	_
 Added Pin Configurati Modes Application an 										
	Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section						1			
Added footnote to INL, GE, and Crosstalk specifications.						6				
Changed t _{DOD1} specification to 27ns					12					
Added sentence to the end of the Reset and Restart section						32				
Deleted CH_STS from Compute the CRC sentence						40				
The datasheet number will be changing.										
Device Family		Change From:			Change To:					
LMP90097/98/99/LMP90		0100 SNAS510P			SNAS510R					
These changes may be reviewed at the datasheet links provided.										
http://www.ti.com/product/Imp90100										
Reason for Change:										
To more accurately reflect device characteristics.										
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):										
Electrical specification performance changes as indicated above.										
Changes to product identification resulting from this PCN:										
None.										
Product Affected:										
		LMDOOO	OMUE	LMDOOOOM	105/	NO	DP	LMDC	010004	IE/NODD
LMP90097MH/NOP	<u> </u>	LMP9009			MP90099MHE/NOPB			LMP90100MHE/NOPB		
LMP90097MHE		LMP9009	8MHE/NOPB	LMP90099M	099MHX/NOPB LMP9010		0100MH	IX/NOPB		

LMP90097MHE/NOPB	LMP90098MHX/NOPB	LMP90100MH	
LMP90097MHX/NOPB	LMP90099MH/NOPB	LMP90100MH/NOPB	
LMP90098MH/NOPB	LMP90099MHE	LMP90100MHE	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com